



Industrial Consultancy & Sponsored Research (IC&SR)

A METHOD FOR NON-DESTRUCTIVE STRUCTURAL HEALTH MONITORING **IITM Technology Available for Licensing**

Problem Statement

Indian Institute of Technology Madras

- Current structural health monitoring methods often require structures to be taken out of service for inspection, leading to downtime and cost.
- There is a **need for a non-destructive**, in-service monitoring solution that can provide real-time structural health data without disrupting normal operations, thereby optimizing maintenance schedules and ensuring safety more effectively.

Technology Category/Market

Category - Non-destructive Testing (NDT) and Structural Health Monitoring Technology.

Applications – Aerospace engineering, Manufacturing Industry - Aerospace, civil engineering, infrastructure management, manufacturing, and oil and gas

Market - Destructive Testing (NDT) Market was valued at USD 6.30 billion in 2021 and is expected to witness significant growth, reaching USD 16.66 billion by 2029, with a projected compound annual growth rate CAGR of 13.66% during the forecast period.

Intellectual Property

- IITM IDF Ref. 861
- **IN 373492 (PATENT GRANTED)**

Key Features / Value Proposition

Technical Perspective:

This invention employs advanced cameras and computational techniques for non-destructive structural health monitoring, enabling real-time data collection and analysis.

User Perspective:

The invention is passive, in-service monitoring solution that optimizes maintenance schedules, enhances productivity, and ensures structural safety without the need for downtime or service interruption.

Technology

Multiple Cameras:

The invention utilizes two or more cameras with adjustable orientations for capturing images of the structure.

Programmable Hardware Platform:

It employs a hardware platform capable of controlling image acquisition, performing Digital Image Correlation (DIC) computations, and post-processing results.

DIC Computation:

Digital Image Correlation is used to analyze image data and calculate three-dimensional displacements of the area of interest.

Mechanical Enclosure:

The device is housed within a protective enclosure, ensuring its durability and suitable mounting on the structure.

Versatility:

The technology can adapt to various structures and sizes, capturing images at different frequencies, making it suitable for a wide range of applications.

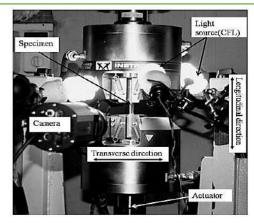


Fig.1 Experimental setup: specimen, periodic image camera, sample illumination lamps, and cyclical loading mechanical actuator.

CONTACT US

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Images

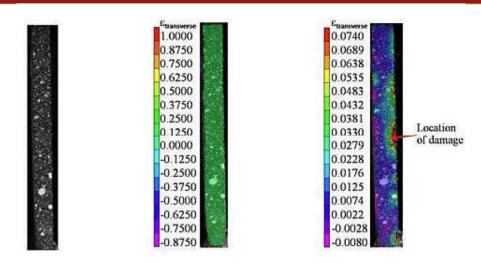


Fig.2 shows typical images and outputs from DIC.

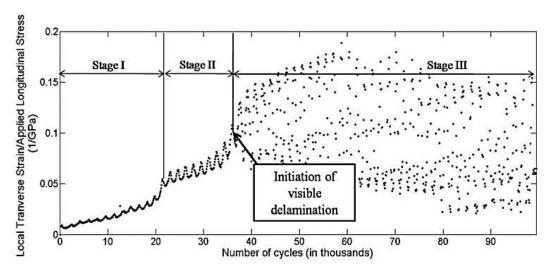


Fig.3 depicts evolution of specimen compliance with number of loading cycles, showing different stages of damage.

TRL (Technology Readiness Level)

TRL- 6, Technology demonstrated in relevant environment.

Research Lab

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